This Page Is Inserted by IFW Operations and is not a part of the Official Record

BEST AVAILABLE IMAGES

Defective images within this document are accurate representations of the original documents submitted by the applicant.

Defects in the images may include (but are not limited to):

- BLACK BORDERS
- TEXT CUT OFF AT TOP, BOTTOM OR SIDES
- FADED TEXT
- ILLEGIBLE TEXT
- SKEWED/SLANTED IMAGES
- COLORED PHOTOS
- BLACK OR VERY BLACK AND WHITE DARK PHOTOS
- GRAY SCALE DOCUMENTS

IMAGES ARE BEST AVAILABLE COPY.

As rescanning documents will not correct images, please do not report the images to the Image Problem Mailbox.



Applicant: Hubert DE STEUR et al. Case No.: 32860-000291/US

Serial No.: 10/079,896 Filing Date: December 27, 2001

Title: METHOD AND APPARATUS FOR STRUCTURING PRINTED CIRCUIT BOARDS

Please acknowledge receipt of: Letter Claiming Priority, Priority document Number 110 27 357.6

By stamping and returning to Harness, Dickey & Pierce, P.L.C.

rickey & Pierce, P.L.C. USPTO Date Stamp

Due: N/A Attorney: DJD - May 20, 2002





PATENT 32860-000291/US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Hubert DE STEUR et al.

Application No.:

10/076,896

Filed:

December 27, 2001

For:

METHOD AND APPARATUS FOR STRUCTURING PRINTED

CIRCUIT BOARDS

PRIORITY LETTER

May 20, 2002

Honorable Commissioner of Patents and Trademarks Washington, DC 20231

Dear Sirs:

Pursuant to the provisions of 35 U.S.C. 119, enclosed is/are a certified copy of the following priority document(s).

Application No.

Date Filed

Country

101 27 357.6

6 June 2001

Germany

46,175

In support of Applicant's priority claim, please enter this document into the file.

Respectfully submitted,

HARNESS, DICKEY, & PIERCE, P.L.C.

Donald J. Dale

P.O. Box 8910 Reston, Virginia 20195

(703) 390-3030

DJD:kmh

BUNDESREPUBLIK DEUTSCHLAND



"Method and Apparatus
for structuring Printed
Oircuit Boards."
10/079,896

Prioritätsbescheinigung über die Einreichung einer Patentanmeldung

Aktenzeichen:

101 27 357.6

Anmeldetag:

6. Juni 2001

Anmelder/Inhaber:

Siemens Dematic AG, Nürnberg/DE

Bezeichnung:

Verfahren und Einrichtung zur Strukturierung

von Leiterplatten

IPC:

H 05 K 3/02

Die angehefteten Stücke sind eine richtige und genaue Wiedergabe der ursprünglichen Unterlagen dieser Patentanmeldung.

München, den 4. März 2002 Deutsches Patent- und Markenamt Der Präsident

Im Auffrag

Waling